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- 1. GENERAL SPECIFICATIONS
- 1.1 DATA SHEET FOR LCD MODULE CONTROLLER/DRIVER PLEASE REFER TO:

SITRONIX ST7262

1.2 DATA SHEET FOR CAPACITIVE TOUCH PANEL CONTROLLER/DRIVER PLEASE REFER TO:

ILITEK ILI2511

- 1.3 MATERIAL SAFETY DESCRIPTION
 ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS,
 INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD,
 MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED
 BIPHENYLS (PBB) AND POLYBROMINATED
 DIPHENYL ETHERS (PBDE), BIS(2-ETHYLHEXYL) PHTHALATE (DEHP), BUTYL
 BENZYL PHTHALATE (BBP), DIBUTYL PHTHALATE (DBP), DIISOBUTYL
 PHTHALATE (DIBP).
- 2. MECHANICAL SPECIFICATIONS
 - 2.1 LCD MODULE MECHANICAL SPECIFICATIONS

(1) DIAGONALS	5 inch
(2) NUMBER OF DOTS	800W * (RGB) * 480H DOTS
(3) MODULE SIZE	118.5W * 77.55H * 4.66D mm
	(WITHOUT FPC & PROTECT FILM)
(4) VIEWING AREA	110W * 66.8H mm
(5) ACTIVE AREA	108W * 64.8H mm
(6) DOT SIZE	0.045W * 0.135H mm
(7) PIXEL SIZE	0.135W * 0.135H mm
(8) LCD TYPE	TFT , TRANSMISSIVE ,
× 0	NORMALLY BLACK
(9) COLOR	16.7M
(10) VIEWING DIRECTION	SUPER WIDE VIEW
(11) BACK LIGHT	LED , COLOR : WHITE
(12) INTERFACE MODE	RGB 24 BIT, PARALLEL (DE/SYNC
	MODE)

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(1) TOUCH PANEL SIZE	
(2) OUTER DIMENSION	
(3) VIEWING AREA	(WITHOUT FPC) 111W * 67.8H mm
(4) ACTIVE AREA	
(5) INPUT TYPE	MULTI TOUCH
(6) NUMBER OF TOUCH SENSOR	
(7) INTERFACE MODE	
(8) RESOLUTION	16384*9600
\(\)	
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3. ABSOLUTE MAXIMUM RATINGS

3.1 LCD MODULE ELECTRICAL ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	-0.3	4.0	V	
INPUT SIGNAL VOLTAGE	VIN-VSS	- 0.3	4.0	V	
STATIC ELECTRICITY		_		V	NOTE(1)
FOG POWER DISSIPATION	PD_FOG	_	(0.345)	W	
LED BACKLIGHT POWER	PD		(1687)	mW	
DISSIPATION	FD		(1007)	111 VV	
LED BACKLIGHT FORWARD	IF 🔨		(70)	mA °	0
CURRENT	II.	y —	(70)	IIIA	
LED BACKLIGHT REVERSE	VR		(25)	W	0.
VOLTAGE	VR	_	(35)	0	: O'

NOTE (1): LCM SHOULD BE GROUNDED DURING HANDLING LCM.

3.2 CAPACITIVE TOUCH PANEL ELECTRICAL ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY FOR DRIVER	VCC-GND	-0.3	3.6	V	

3.3 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ITEM	OPERATING		STORAGE		REMARK	
I I EM	MIN.	MIN. MAX.		MAX.	KEMAKK	
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE (1), (2)	
HUMIDITY	NOT	NOTE (2)		E(2)	WITHOUT	
HUMIDIT I	NOTE(3)		NOTE(3)		CONDENSATION	
VIBRATION	127	2.45 m/s ²		11.76 m/s^2	10~55Hz	
VIDRATION	(0.25 G)			(1.2 G)	X,Y,Z, EACH 2HRS	
Ó	ກ໌ .	29.4 m/s ²		490 m/s ²	6 ms	
SHOCK	c	(3G)		(50 G)	XYZ DIRECTIONS	
300	(30)			(300)	3 TIMES EACH	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACCEPTABLE			

NOTE (1): Ta AT -30°C: WILL BE 48HRS MAX.

80°C: WILL BE 168HRS MAX.

NOTE (2) : BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT

TEMPERATURE THIS PHENOMENON IS REVERSIBLE.

NOTE (3): $Ta \le 60^{\circ}C : 90\%RH MAX (96HRS MAX)$.

Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY

OF 90%RH AT 60°C(96HRS MAX).

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4. ELECTRICAL CHARACTERISTICS

4.1 LCD MODULE ELECTRICAL CHARACTERISTICS

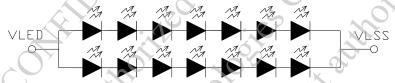
 $Ta = 25 \, ^{\circ}C$

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	_	3.15	3.30	3.45	V	
INPUT HIGH VOLTAGE	VIH		0.7*VDD		VDD	V	NOTE(1)
INPUT LOW VOLTAGE	VIL		VSS		0.3*VDD	V	NOTE(1)
OUTPUT HIGH VOLTAGE	VOH		VDD-0.4		VDD	V	NOTE(1)
OUTPUT LOW VOLTAGE	VOL		VSS		VSS+0.4	V	NOTE(1)
POWER SUPPLY CURRENT	IDD	_		(80)	(100)	mA	NOTE (2)
POWER SUPPLY FOR LED BACKLIGHT	VLED-VLSS	ILED=40mA	(18.5)	(23.1)	(24.1)	v	NOTE(3)
LED LIFE TIME		IF=20mA (PER LED)	(30000)	(40000)	200	HOURS	NOTE (5) NOTE (6)

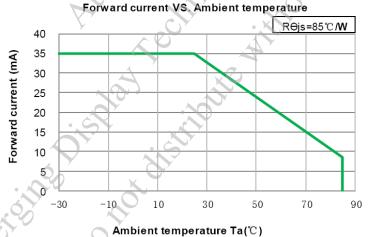
NOTE (1): APPLIED TO TERMINALS, DR0~DR7, DG0~DG7, DB0~DB7, DCLK, STBYB, HSYNC, VSYNC, DE.

NOTE (2): THE DISPLAY PATTERN IS ALL "WHITE".

NOTE (3): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT



NOTE (4): AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT.(PER LED)



NOTE (5): CONDITIONS; TA=25 °C, CONTINUOUS LIGHTING.

NOTE (6): DEFINITIONS OF LIFE TIME:

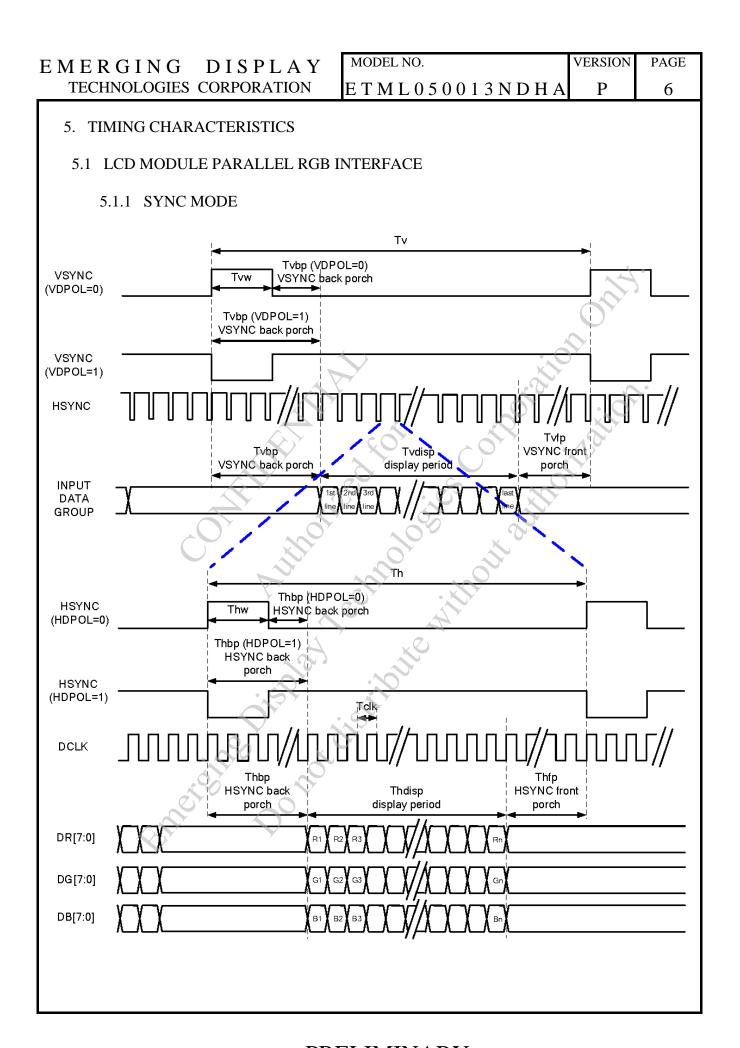
LCM LUMINANCE BECOMES HALF OF THE INITIAL VALUE.

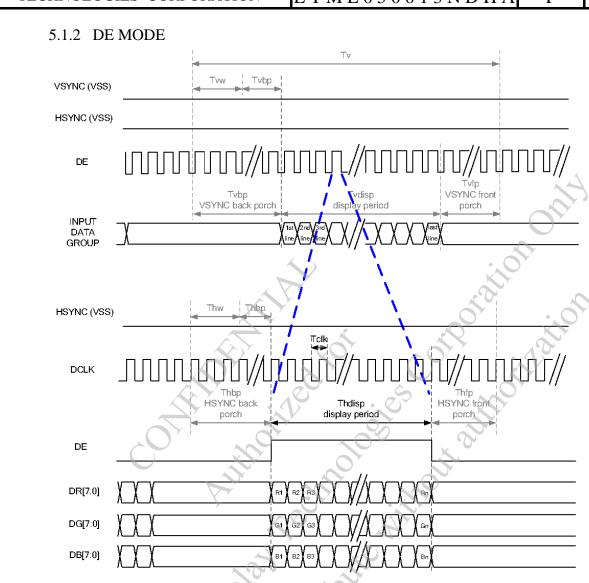
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4.2 CAPACITIVE TOUCH PANEL ELECTRICAL CHARACTERISTICS

Га	=2.5	\circ C

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	Ta=25°0 UNIT
POWER SUPPLY FOR DRIVER	VCC-GND	_	3.15	3.30	3.45	V
INPUT HIGH LEVEL VOLTAGE	VIH	_	0.6*VCC		VCC+0.5	V
NPUT LOW LEVEL VOLTAGE	VIL		0		0.3*VCC	V
OUTPUT HIGH LEVEL VOLTAGE	VOH	IOH=8mA	0.7*VCC		_	V
OUTDUT LOW LEVEL VOLTAGE	VOL	IOL=10mA	_		0.3*VCC	V
POWER SUPPLY CURRENT CONSUMPTION FOR OPERATION	ICC	VCC-GND =3.30V		(75)	(120)	° mA
		VCC-GND =3.30V	SSON		A LOUISIAN	>°





5.1.3 TIMING TABLE

	ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK FREQ	UENCY	Fclk	25	25	27	MHz
	PERIOD TIME	Th	808	816	896	DCLK
	DISPLAY PERIOD	Thdisp	800	800	800	DCLK
HSYNC	BACK PORCH	Thbp	4	8	48	DCLK
~ ~	FRONT PORCH	Thfp	4	8	48	DCLK
	PULSE WIDTH	Thw	2	4	6	DCLK
y	PERIOD TIME	Tv	488	496	504	HSYNC
	DISPLAY PERIOD	Tvdisp	480	480	480	HSYNC
VSYNC	BACK PORCH	Tvbp	4	8	12	HSYNC
	FRONT PORCH	Tvfp	4	8	12	HSYNC
	PULSE WIDTH	Tvw	2	4	8	HSYNC

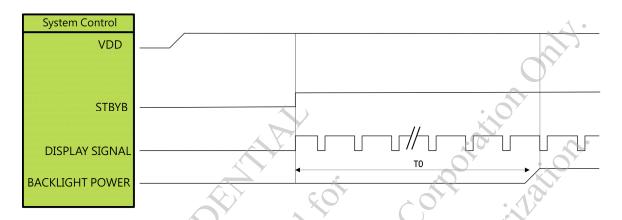
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5.2 POWER ON-OFF TIMING SEQUENCE FOR LCD MODULE

5.2.1 POWER ON SEQUENCE

SYMBOL	DESCRIPTION	MIN. TIME	UNIT
T0	DISPLAY SIGNAL OUTPUT TO BACKLIGHT POWER ON	250	ms

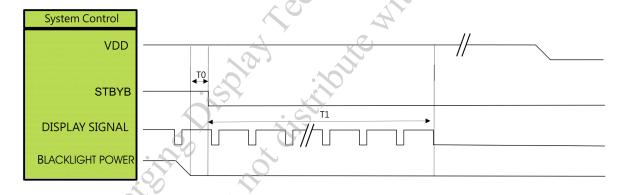
NOTE: RGB INTERFACE DISPLAY SIGNAL: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]



5.2.2 POWER OFF TIMING SEQUENCE

SYMBOL	DESCRIPTION	MIN. TIME	UNIT
T0	BACKLIGHT POWER OFF TO DISP="LOW"	5	ms
T1	DISP="LOW" TO IC INTERNAL VOLTAGE DISCHARGE COMPLETE	100	ms

NOTE: RGB INTERFACE DISPLAY SIGNAL: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]

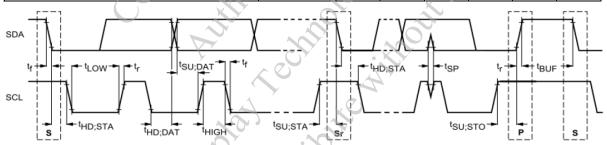


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5.3 CAPACITIVE TOUCH PANEL TIMING CHARACTERISTICS

5.3.1 I2C INTERFACE TIMING CHARACTERISTICS

ITEM	SYMBOL	STAN	DARD I	MODE	FA	ST MO	DE
HEM	SIMBOL	MIN.	MAX.	UNIT	MIN.	MAX.	UNIT
SCL CLOCK FREQUENCY	f_{SCL}	0	100	kHz	0	400	kHz
HOLD TIME (REPEATED) START CONDITION. AFTER THIS PERIOD, THE FIRST CLOCK PULSE IS GENERATED	$t_{ m HD;STA}$	4.0		μs	0.6	_	µs
LOW PERIOD OF THE SCL CLOCK	t_{LOW}	4.7		μs	1.3		μs
HIGH PERIOD OF THE SCL CLOCK	$t_{ m HIGH}$	4.0	_	μs	0.6		μs
SET-UP TIME FOR A REPEATED START CONDITION	t _{SU;STA}	4.7	_	μs	0.6	_	μs
DATA HOLD TIME	$t_{\mathrm{HD;DAT}}$	5.0		μs	0	0.9	μs
DATA SET-UP TIME	t _{SU;DAT}	250		ns	100	- -	ns
RISE TIME OF BOTH SDA AND SCL SIGNALS	t _r	_	1000	ns	_	300	ns
FALL TIME OF BOTH SDA AND SCL SIGNALS	$t_{\rm f}$		300	ns		300	ns
SET-UP TIME FOR STOP CONDITION	t _{SU;STO}	4.0	P	μs	0.6		μs
BUS FREE TIME BETWEEN A STOP AND START CONDITION	$t_{ m BUF}$	4.7		μs	1.3		μs

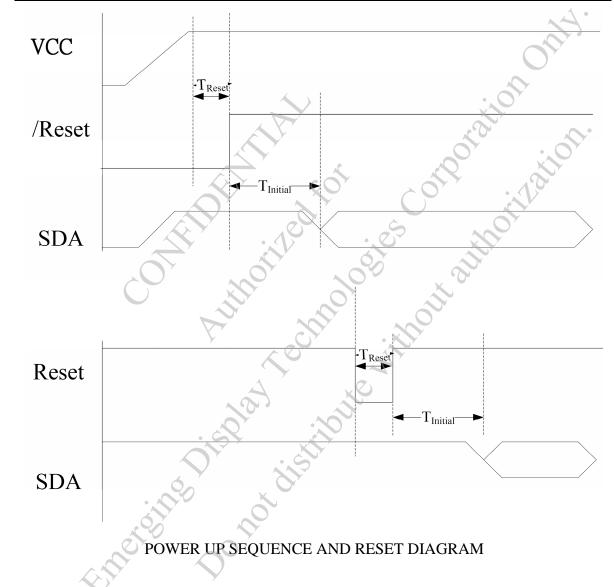


THE TIMING OF I2C INTERFACE

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5.3.2 POWER-ON SEQUENCE

ITEM	SYMBOL	MIN.	MAX.	UNIT
AFTER POWERING-ON OR RESETTING THE DEVICE, THE DEVICE NEEDS INITIAL TIME TO CONFIGURE THE SYSTEM.	${ m T_{Initial}}$		100	ms
RESET PIN LOW HOLD TIME	T_{Reset}	50	_	us



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6. OPTICAL CHARACTERISTICS

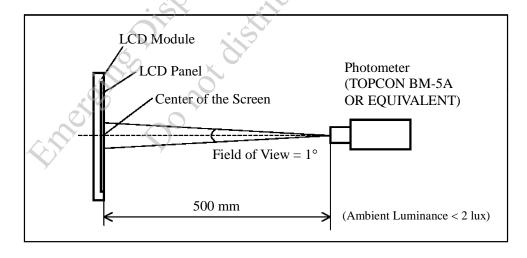
6.1 OPTICAL CHARACTERISTICS

 $Ta=25\pm2$ °C

ITEM		SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK
		θ_{y^+}		$\theta_x=0^{\circ}$	(70)	(80)	_		
VIEWING ANGLE		$\theta_{ ext{y-}}$	CD>10	θ_{x} –0	(70)	(80)		1	NOTE(2)
VIEWING ANGLE		θ_{x+}	CR≥10	(70)	(80)		deg.	NOTE(3)	
		θ_{x}		$\theta_y=0^{\circ}$	(70)	(80)	_	< C	S
CONTRAST RATIO (CENTER))	CR	θx=0°,	θу=0°	(800)	(1000)	_	0	NOTE(3)
RESPONSE TIME		TR(rise)+ TF(fall)	θx=0°,	θу=0°		(30)	(40)	msec	NOTE (4)
	WHITE	Wx			(0.275)	(0.325)	(0.375)		
	WILLE	Wy	(Y		(0.298)	(0.348)	(0.398)	_	
COLOR RED		Rx	, , , , , , , , , , , , , , , , , , ,	K	(0.570)	(0.620)	(0.670)	X	Y
COLOR CHROMATICITY	KED	Ry		60,	(0.278)	(0.328)	(0.378)	. 75	NOTE (5)
(CENTER)	GREEN	Gx	7	Y	(0.284)	(0.334)	(0.384)		NOTE (5)
	GREEN	Gy		0y=0° SS=3.3V	(0.494)	(0.544)	(0.594)	>-	
	BLUE	Bx	- \ \ /	53−3.3 v = 40mA	(0.086)	(0.136)	(0.186)		
	BLUE	Ву	0		(0.093)	(0.143)	(0.193)		
THE BRIGHTNESS	OF	В			380	420		cd/m²	NOTE (6)
MODULE (CENTER)		Б			360	420		Cu/III-	NOIE (0)
THE UNIFORMITY OF			Ĉ		(70)			%	NOTE (7)
MODULE			10	J	(70)	J'		70	NOIE (7)

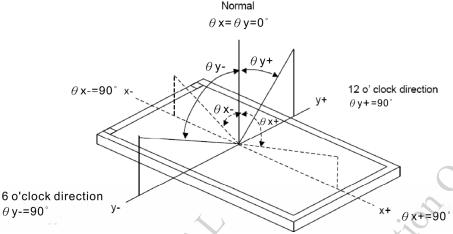
NOTE (1): TEST CONDITION:

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM.



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NOTE (2): DEFINITION OF VIEWING ANGLE:



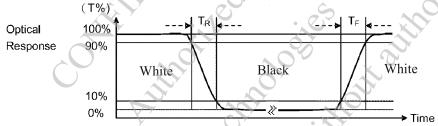
NOTE (3): DEFINITION OF CONTRAST RATIO (CR):

MEASURED AT THE CENTER POINT OF MODULE

CONTRAST RATIO(CR) = $\frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$

NOTE (4) : DEFINITION OF RESPONSE TIME : T_R AND T_F

THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



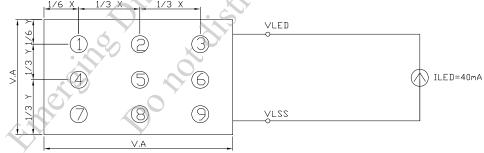
NOTE (5): DEFINITION OF COLOR CHROMATICITY

(a)100% RGB PIXEL DATA TRANSMISSION WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY POWERED ON.

(b)MEASURED AT THE CENTER POINT OF MODULE

NOTE (6): MEASURED THE BRIGHTNESS OF WHITE STATE AT CENTER POINT.

NOTE (7): (a) DEFINITION OF BRIGHTNESS UNIFORMITY



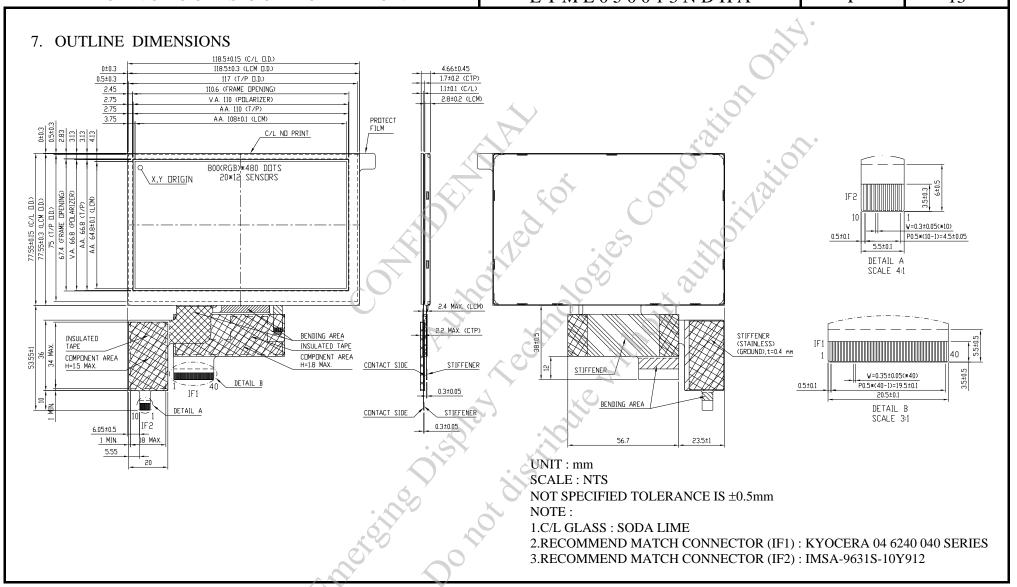
UNIT: mm

(b)THE BRIGHTNESS UNIFORMITY CALCULATING METHOD

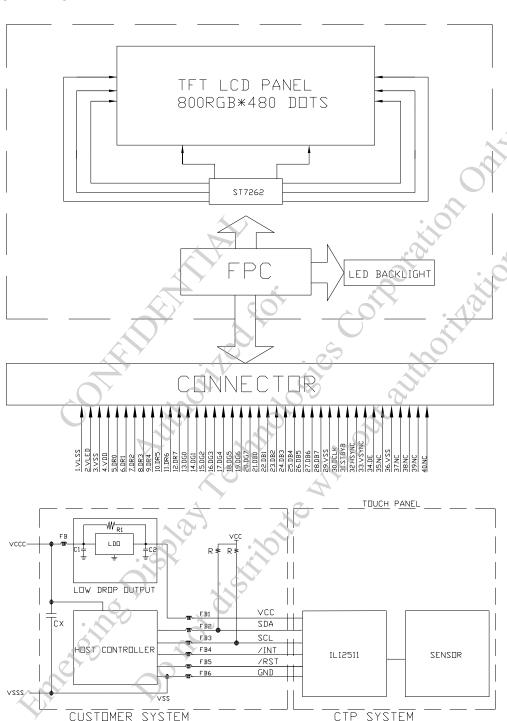
UNIFORMITY: MINIMUM BRIGHTNESS *100%

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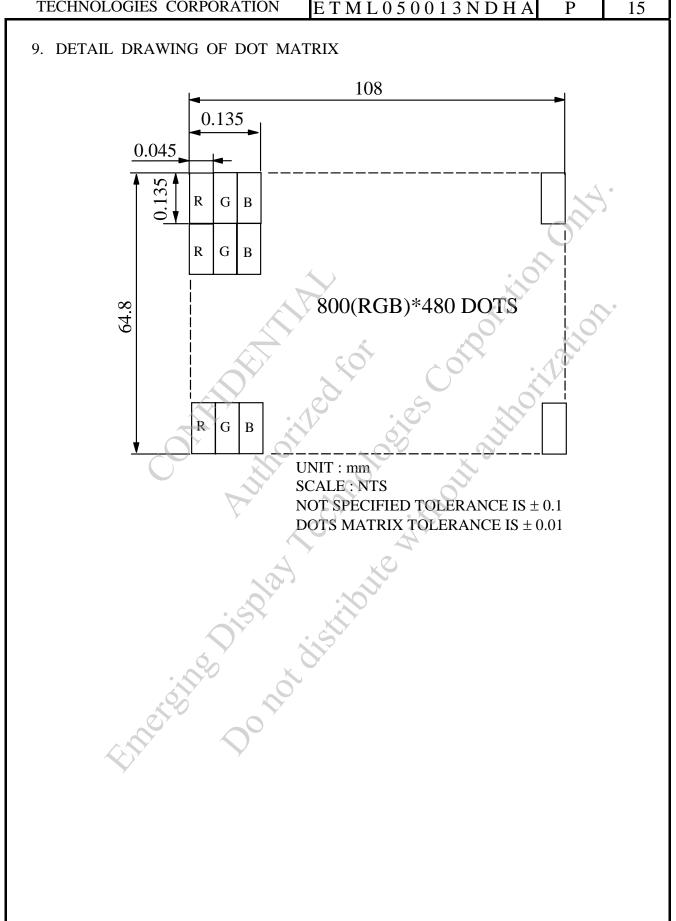
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8. BLOCK DIAGRAM



- NOTE (1): THE STANDARD IIC COMMUNICATION INTERFACE, SUPREME SCL CLOCK IS 400 KHz, SLAVE ADDRESS CAN BE SET UP, SUPPORTS VDD LEVEL POWER, NEEDS PULL HIGH RESISTANCE AND WE RECOMMEND THE PULL HIGH RESISTANCE IS 2.0K OHM.
- NOTE (2) : POWER SUPPLY SHALL BE CLEAN AND NOISE FREE. ADDITIONAL FILTERING OR A SEPARATE LDO (LOW DROP OUT) REGULATOR CAN BE REQUIRED. C1 AND C2 CAPACITORS RECOMMENDATION : $4.7\mu F$ OR $10~\mu F$



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10. INTERFACE SIGNALS

10.1 IF1

PIN NO.	SYMBOL	FUNCTION
1	VLSS	POWER SUPPLY FOR LED BACKLIGHT (CATHODE SIDE)
2	VLED	POWER SUPPLY FOR LED BACKLIGHT (ANODE SIDE)
3	VSS	GROUND
4	VDD	POWER SUPPLY VOLTAGE
5	DR0	O'
6	DR1	
7	DR2	
8	DR3	DISPLAY DATA (R)
9	DR4	DR0 LSB DR7 MSB
10	DR5	
11	DR6	
12	DR7	
13	DG0	
14	DG1	
15	DG2	
16	DG3	DISPLAY DATA (G) DG0 LSB
17	DG4	DG7 MSB
18	DG5	
19	DG6	4 ,0
20	DG7	
21	DB0	
22	DB1	
23	DB2	
24	DB3	DISPLAY DATA (B) DB0 LSB
25	DB4	DB7 MSB
26	DB5	
27	DB6	
28	DB7	,
29	VSS	GROUND
30	DCLK	CLOCK SIGNAL FOR DATA LATCHING AND INTERNAL COUNTER OF THE TIMING CONTROLLER
31	STBYB	STANDBY MODE CONTROL SIGNAL LO: TCON AND SOURCE DRIVER ARE OFF HI : ALL THE FUNCTIONS ARE ON

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PIN NO.	SYMBOL	FUNCTION
32	HSYNC	HORIZONTAL SYNC SIGNAL
33	VSYNC	VERTICAL SYNC SIGNAL
34	DE	INPUT DATA ENABLE CONTROL, WHEN DE MODE, ACTIVE HIGH TO ENABLE DATA INPUT, NORMALLY PULL LOW
35	NC	NON CONNECTION
36	VSS	GROUND
37	NC	NON CONNECTION
38	NC	NON CONNECTION
39	NC	NON CONNECTION
40	NC	NON CONNECTION

10.2 IF2

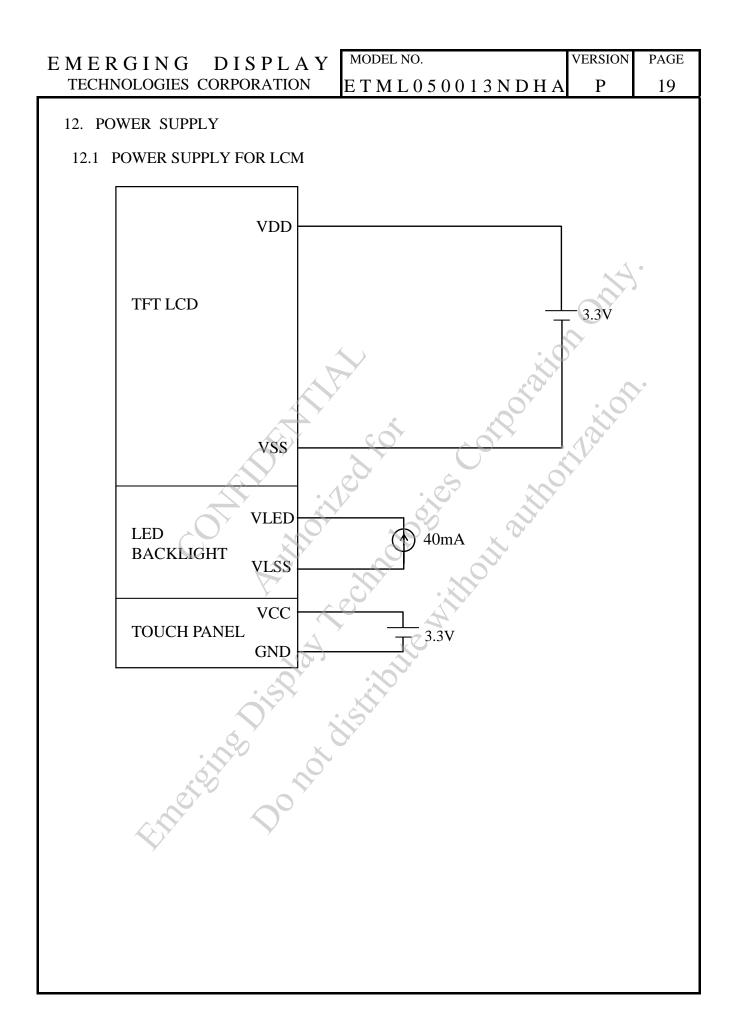
PIN NO.	SYMBOL	FUNCTION			
1	GND	GROUND			
2	/RST	EXTERNAL RESET, LOW IS ACTIVE (+3.3V)			
3	/INT	EXTERNAL INTERRUPT TO THE HOST (+3.3V)			
4	SCL	I2C CLOCK INPUT (+3.3V)			
5	SDA	I2C DATA INPUT AND OUTPUT (+3.3V)			
6	VCC	POWER SUPPLY VOLTAGE (+3.3V)			
7	NC	THE PIN WAS RESERVED FOR USB VDD (+5.0V)			
8	NC	THE PIN WAS RESERVED FOR USB D-			
9	NC	THE PIN WAS RESERVED FOR USB D+			
10	NC	THE PIN WAS RESERVED FOR USB GND			
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11. PROTOCOL

Ox10 TOUCH REPORTED GET THE NUMBERS OF THE TOUCH INFORMATION REPORT	CMD CODE	NAME	SET/GET	В7	В6	В5	B4	В3	B2	B1	В0
0x11 TOUCH INFORMATION REPORT GET STATUS	0x10		GET	THE NUM	THE NUMBERS OF THE TOUCH INFORMATION REPORT						
0x11 REPORT STATUS TOUCH KEY REPORT GET TOUCH REPORTED_ID STATUS TOUCH KEY ID 0x00 0xFF 0xFF THE MAXIMUM X COORDINATE (BIT 15:8) THE MAXIMUM Y COORDINATE (BIT 15:8) THE MAXIMUM Y COORDINATE (BIT 15:8) THE CHANNEL NUMBERS OF X DIRECTION THE CHANNEL NUMBERS OF Y DIRECTION THE CHANNEL NUMBERS OF TOUCHKEY FOR TOUCH KEY APPLICATION (MAXIMUM SUPPORTS 31 TOUCH KE BYTE 8: THE TOUCH KEY NUMBER (<32) BYTE 9: 0xFF 0x30 ENTER SLEEP MODE SET CHIP ID CODE MAJOR FIRMWARE VERSION MINOR FIRMWARE VERSION RELEASE FIRMWARE VERSION		TOLICH INFORMATION		0 REPORTED_ID							
Y POSITION (BIT 15:8) OF THE FINGER Y POSITION (BIT 7:0) OF THE FINGER TOUCH STATUS TOUCH KEY REPORT GET TOUCH KEY ID 0x00 0xFF 0xFF THE MAXIMUM X COORDINATE (BIT 15:8) THE MAXIMUM Y COORDINATE (BIT 15:8) THE MAXIMUM Y COORDINATE (BIT 15:8) THE CHANNEL NUMBERS OF Y DIRECTION THE CHANNEL NUMBERS OF Y DIRECTION THE CHANNEL NUMBERS OF TOUCHKEY FOR TOUCH KEY APPLICATION (MAXIMUM SUPPORTS 31 TOUCH KE BYTE 8: THE TOUCH KEY NUMBER (<32) BYTE 9: 0xFF 0x30 ENTER SLEEP MODE SET CHIP ID CODE MAJOR FIRMWARE VERSION MINOR FIRMWARE VERSION RELEASE FIRMWARE VERSION RELEASE FIRMWARE VERSION	0x11		GET		`					4	
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Date of the channel numbers of x direction The channel numbers of y direction The maximum report points The channel numbers of touchkey For touch key application (maximum supports 31 touch key byte 8 : the touch key number (<32) Byte 9: 0xff Ox30 Enter sleep mode Set Chip id code Major firmware version Minor firmware version Release firmware version Release firmware version			THE MAXIMUM Y COORDINATE (BIT 7:0)								
Ox20 PANEL INFORMATION GET THE CHANNEL NUMBERS OF Y DIRECTION THE MAXIMUM REPORT POINTS THE CHANNEL NUMBERS OF TOUCHKEY FOR TOUCH KEY APPLICATION (MAXIMUM SUPPORTS 31 TOUCH KE BYTE 8: THE TOUCH KEY NUMBER (<32) BYTE 9: 0xFF Ox30 ENTER SLEEP MODE SET CHIP ID CODE MAJOR FIRMWARE VERSION MINOR FIRMWARE VERSION RELEASE FIRMWARE VERSION		_	THE MAXIMUM Y COORDINATE (BIT 15:8)								
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FOR TOUCH KEY APPLICATION (MAXIMUM SUPPORTS 31 TOUCH KE BYTE 8 : THE TOUCH KEY NUMBER (<32) BYTE 9 : 0xFF 0x30 ENTER SLEEP MODE SET CHIP ID CODE MAJOR FIRMWARE VERSION MINOR FIRMWARE VERSION RELEASE FIRMWARE VERSION											
BYTE 8 : THE TOUCH KEY NUMBER (<32) BYTE 9: 0xFF 0x30 ENTER SLEEP MODE SET CHIP ID CODE MAJOR FIRMWARE VERSION MINOR FIRMWARE VERSION RELEASE FIRMWARE VERSION		, O y							unn o n ma	24 marrar	
0x30 ENTER SLEEP MODE SET CHIP ID CODE MAJOR FIRMWARE VERSION MINOR FIRMWARE VERSION 0x40 FIRMWARE VERSION GET GET				BYTE 8: THE TOUCH KEY NUMBER (<32)					KEY)		
CHIP ID CODE MAJOR FIRMWARE VERSION MINOR FIRMWARE VERSION RELEASE FIRMWARE VERSION GET	0×30	ENTED SI EED MODE	CET	BYTE 9: 0x	FF		-0	1.			
MAJOR FIRMWARE VERSION MINOR FIRMWARE VERSION RELEASE FIRMWARE VERSION Ox40 FIRMWARE VERSION	UAJU	ENTER SEEE, MODE	OE1	CHIP ID CO	DDE	^					
0x40 FIRMWARE VERSION GET MINOR FIRMWARE VERSION			,								
0x40 FIRMWARE VERSION GET RELEASE FIRMWARE VERSION											
0x40 FIRMWARE VERSION GET			RELEASE FIRMWARE VERSION								
FOR CUSTOMER FIRMWARE VERSION	0x40	FIRMWARE VERSION GET FOR CUSTOMER FIRMWARE VERSION									
FOR CUSTOMER FIRMWARE VERSION											
FOR CUSTOMER FIRMWARE VERSION			5								
FOR CUSTOMER FIRMWARE VERSION											
MAJOR PROTOCOL VERSION : 0X02			/								
0x42 PROTOCOL VERSION GET MINOR PROTOCOL VERSION : XX	0x42	PROTOCOL VERSION	GET	MINOR PR	OTOCOL	VERSION	I : XX				
RELEASE PROTOCOL VERSION : XX			(



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13. CAPACITIVE TOUCH PANEL SPECIFICATION

13.1 OPTICAL CHARACTERISTICS

ITEM	CONDITION	MIN.	TYP.	MAX.	UNIT
TRANSPARENCY	Ta = 25°C	(85)			%
NOTE (1)	1a – 25 C	(65)	_	_	70

NOTE (1) : OPTICAL MEASUREMENT SHOULD BE EXECUTED AFTER PANEL IS SECURED.

MEASUREMENT PROCESS SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM.

OPTICAL SPECIFICATIONS SHOULD BE MEASURED BY SPECTROPHOTOMETER.

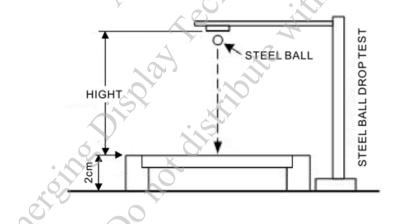
13.2 HARDNESS

ITEM	DESCRIPTION
SURFACE HARDNESS	(7H) (MIN.)

13.3 DURABILITY

USING STEEL BALL AND FALLING ON TOUCH PANEL SURFACE, FROM THE HEIGHT MUST PASS BELOW CONDITIONS:

ITEM	CONDITION	INSPECTION METHOD	DESCRIPTION
STEEL BALL DROP TEST	WEIGHT: 67g HEIGHT OF FALL: 30 cm	VISUAL	SIGN OF FRACTURE OR DAMAGE IS NOT ACCEPTABLE 3 TIME/ 1 POINTS, 25°C (CENTER POINT)



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TECHNOLOGIES CORPORATION

14. INSPECTION CRITERION

14.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) TO **CUSTOMERS**

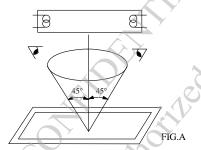
14.2 INSPECTION CONDITIONS

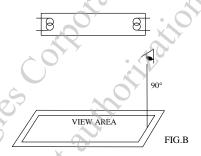
14.2.1 (1)OBSERVATION DISTANCE: 45±5cm

(2) VIEWING ANGLE: ±45°

±45° (FOR SECTION WITHIN VIEWING AREA), REFER TO FIG.A 90° (FOR SECTION OUTSIDE OF VIEWING AREA), REF TO FIG.B PERPENDICULAR TO MODULE SURFACE

VIEWING ANGLE SHOULD BE SMALLER THAN 45°





THE INSPECTION CRITERIA IS ACCORDING TO LINE OF SIGHT. INSPECTION SHALL BE MADE WITHIN THE HALF SECTION OF THE VIEWING CONE GENERATED BY LINE SEGMENT OF 45° WITH RESPECTS TO THE VERTICAL AXIS FROM CENTER VERTEX OF LCD, THE FLUORESCENT LAMP AND THE CONE AXIS MUST BE PERPENDICULAR TO THE LCD SURFACE.

IF THE DEFECTS ARE OUTSIDE OF VIEWING AREA, IT SHALL BE INSPECTED BY 90° WITH RESPECTS TO THE VERTICAL AXIS FROM EDGE OF VIEWING AREA.

14.2.2 ENVIRONMENT CONDITIONS

AMBIEN	25±5°C
AMBI	$65 \pm 20\% RH$
AMBIENT	600~800 lux
ILLUMINATION	300~500 lux
INSP	10 secs

14.2.3 INSPECTION LOT

QUANTITY PER DELIVERY LOT FOR EACH MODEL

14.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY

(a)APPLICABLE STANDARD:

ANSI/ ASQ Z1.4 NORMAL INSPECTION LEVEL II

(b)AQL: MAJOR DEFECT: AQL 0.65 MINOR DEFECT: AQL 1.0

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14.3 DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
	<u> </u>	• DEFECT TO MISS SPECIFIED	
		DISPLAY FUNCTION, FOR ALL	
	1.DISPLAY ON	AND SPECIFIED DOTS	
		EX: DISCONNECTION, SHORT	
MAJOR REFERE		CIRCUIT ETC	0.65
MAJOR DEFECT		• NO LIGHT	0.65
	2.BACKLIGHT	• FLICKERING AND OTHER	
		ABNORMAL ILLUMINATION	
	3.DIMENSIONS	• SUBJECT TO INDIVIDUAL	
	5.DIMENSIONS	ACCEPTANCE SPECIFICATIONS	
		• BLACK/WHITE SPOT	
		BUBBLES ON POLARIZER	
		• NEWTON RING	
	1.DISPLAY ZONE	• BLACK/WHITE LINE	
		• SCRATCH	
		• CONTAMINATION	
	.10	• LEVER COLOR SPREAD	
		• STAINS	
MINOR DEFECT	2.BEZEL ZONE	• SCRATCHES	1.0
MINOR DEFECT		• FOREIGN MATTER	1.0
	100 N	• INSUFFICIENT SOLDER	
	γ'	• SOLDERED IN INCORRECT	
	a got DEDING	POSITION	
	3.SOLDERING	• CONVEX SOLDERING SPOT	
		• SOLDER BALLS	
		• SOLDER SCRAPS	
	4.DISPLAY ON	• LIGHT LINE	
	(ALL ON)	7	
Cinci d	(ALLON)		

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NO.	ITEM		CRITEI	RIA	
1	DISPLAY ON INSPECTION	1. INCORRECT PATTERN 2. MISSING SEGMENT 3. DIM SEGMENT 4. OPERATING VOLTAGE	2. MISSING SEGMENT		
2	OVERALL DIMENSIONS	1. OVERALL DIMENSION	BEYOND SP	EC	
3	DOT DEFECT	1. INSPECTION PATTERN: AND BLUE SCREENS. 2. ITEMS BRIGHT DOT DARK DOT TOTAL BRIGHT AND DA NOTE: (1)THE DEFINITION OF DO THE SIZE OF A DEFECT REGARDED AS ONE DE (2)BRIGHT DOT: DOTS APPEAR BRIGHT PANEL IS DISPLAYING THE BRIGHT DOT DEFE FILTER. (3)DARK DOT: DOTS APPEAR DARK A PANEL IS DISPLAYING	ARK DOTS OT: TVE DOT OVERECTIVE DOT AND UNCHAUNDER BLACT MUST BE	PERMIS NOTE PERMIS PERMIS	SSIBLE NO. N \leq 2 N \leq 3 N \leq 4 WHOLE DOT IS SIZE IN WHICH LCD ERN. THROUGH 5% ND IZE IN WHICH LCD
4	BUBBLES ON POLARIZER /SURFACE STAINS /DIRT/CF FAIL/SPOT	BUBBLE SHAL APPEARS ON T (2)THE EXTRANE OBSERVED W	SPLAY AREAL BE IGNORITHE OUTSIDE EOUS SUBSTHEN THE MOON OF AVERIGE.	D 25 ≤ 0.5 D .1 ≤ 0.3 D .1 ≤ 0.3 D .FINED AS A. THE DEL ED IF THE E OF ACTI ANCE IS D DULE IS 1 AGE DIAN	FECT OF POLARIZER POLARIZER BUBBLE VE DISPLAY AREA. DEFINED AS IT CAN BE

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Ο.	ITEM		CRITERIA		
<i>J</i> .	I I EIVI	THE FOLLOWING BLACK/WHITE SPO			
		VIEWING AREA. AVERAGE DIAMETER: D (mm)			
		SIZE D	PERMISSIBLE NO.	,	
		D≤0.15	IGNORE	D /	
5	BLACK/WHITE SPOT CIRCULAR	0.15 <d≤0.3< td=""><td>4</td><td></td></d≤0.3<>	4		
	TYPE	0.13 <d≤0.5 0.3<d≤0.5< td=""><td>2</td><td></td></d≤0.5<></d≤0.5 	2		
		0.5 <d≤0.5 D>0.5</d≤0.5 	0	1	
		NOTE (1): THE DISTANCE BETWE	ű.	<i>'</i>	
		` '			
		SHOULD BE MORE THAT THE FOLLOWING SCRATCH IS WITH			
		WIDTH: W (mm), LENGTH: L (mm)	IN THE VIEWING AREA.		
		SIZE W & L	PERMISSIBLE NO.		
		W≤0.07	IGNORE		
	CCD A TCH		3		
6	SCRATCH	0.07 <w≤0.1, l≤8<="" td=""><td>3</td><td></td></w≤0.1,>	3		
		0.07 <w≤0.1, 8<l≤10<="" td=""><td>0</td><td></td></w≤0.1,>	0		
		W>0.1		O 7	
		NOTE (1): THE DISTANCE BETWE		-	
		SHOULD BE MORE THA			
		THE FOLLOWING BLACK LINE, WHIT VIEWING AREA. WIDTH: W (mm), L.		X	
			PERMISSIBLE NO.	12	
	BLACK /	SIZE W & L		E =	
7	WHITE LINE	W≤0.07	IGNORE 2		
	LINEAR TYPE /	0.07 <w≤0.1, l≤8<="" td=""><td>3 2 4</td><td>$\mathcal{O}(\mathbf{V})$</td></w≤0.1,>	3 2 4	$\mathcal{O}(\mathbf{V})$	
	FOREIGN FIBER	0.07 <w≤0.1, 8<l≤10<="" td=""><td></td><td></td></w≤0.1,>			
		W>0.1	0		
		NOTE (1): THE DISTANCE BETWE			
		SHOULD BE MORE THA	N 10mm APART.		
		BUBBLES WITHIN VIEWING AREA. AVERAGE DIAMETER: D (mm)			
		SIZE D	PERMISSIBLE NO.		
	BUBBLE / DENT	D≤0.2	IGNORE	D	
8	FOR OPTICAL	0.2 <d≤0.3< td=""><td>3</td><td></td></d≤0.3<>	3		
0	BONDING	0.2 <d≤0.5 0.3<d≤0.5< td=""><td>2</td><td></td></d≤0.5<></d≤0.5 	2		
	DONDING	D>0.5	2 0		
		NOTE (1): THE DISTANCE BETWE			
		SHOULD BE MORE THA	The state of the s		
				Chip of gla	
		I I CORNER I	$Y \le 3 \text{mm} \cdot Z \le t$	_	
)	CHIPPING	(t:TH	IICKNESS)		
		I PLICE I	$Y \le 1 \text{mm}, Z < t$	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
		(t:TH	IICKNESS)	✓ v →	
)	CRACKED GLASS	NOT ACCEPTAL	BLE		
1	LINE DEFECT	OBVIOUS VERTICAL OR HORIZO	NTALLINE DEEDCT 10	NOT ALLOW	
L	ON DISPLAY	OBVIOUS VERTICAL OR HORIZO	NIAL LINE DEFECT IS	NOT ALLOW	
2	MURA ON DISPLAY	IT'S ACCEPTABLE, IF MURA IS SI	LIGHT VISIBLE THROU	GH 5% ND FI	
_	UNEVEN COLOR			_	
3	SPREAD,	TO BE DETERMINED BASED UPO	N THE LIMITED SAMPL	Æ.	
3	COLORATION				
3				TE EDICED	
		1. BEZEL MAY NOT HAVE RUST,		E FINGER	
4	BEZEL APPEARANCE	1. BEZEL MAY NOT HAVE RUST, PRINTS STAINS OF OTHER COM 2. BEZEL MUST COMPLY WITH JO	NTAMINATION.	E FINGER	

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NO.	ITEM	CRITERIA
		1. NO SOLDERING FOUND ON THE SPECIFIED PLACE 2. INSUFFICIENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD
		SOLDER FILLET
		(b)CHIP COMPONENT • SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING SOLDER FILLET
		1/2
15	SOLDERING	• SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% O SIDES AND FRONT SURFACE AREA ARE COVERED SOLDER
	A	3. PARTS ALIGNMENT
		(a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE
	Elle Legal	

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NO.	ITEM	CRITERIA
		(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE
15	SOLDERING	
		 4. NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. 5. NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. 6. NO RESIDUE OR SOLDER BALLS ON PCB. 7. NO SHORT CIRCUITS IN COMPONENTS ON PCB.
16	BACKLIGHT	1. NO LIGHT 2. FLICKERING AND OTHER ABNORMAL ILLUMINATION 3. SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. 4. BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
17	GENERAL APPEARANCE	 NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP. NO CRACKS ON INTERFACE PIN (OLB) OF TCP. NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. LCD PIN LOOSE OR MISSING PINS. PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET. THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY

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NO.	ITEM		CRITERIA		
		THE LCD WITH EXTENSIVE	CRACK IS NOT	T ACCEPTABLE	
		GENERAL GLASS CHIP:	a	b	c
		a b	$\frac{\leq t/2}{t/2 > , \leq 2t}$	< VIEWING AREA ≤ W/2	≤ 1/8X ≤ 1/8X
		c	*W=DISTANC		≤ 1/0A
				E BEI WEEN FAREA AND LC	ים
		` `	PANEL EI		ע.
			X = LCD SID		1.
			t = GLASS T	/	
		W, c	t GE/188 1	THEIR (ESS	
					,
		a			
				. 0	
		b		X	
					€.
					0
		N b		X	
				7	
		a			
	_	CORNER PART	a	b	c
		1 . 19 .	≤ t/2	< VIEWING AREA	≤ 1/8X
		b	> t/2 , ≤ 2t	≤ W/2	≤ 1/8X
	, OY	c	*W=DISTANC	E BETWEEN TAREA AND LC	'D
18	CRACKED GLASS	a	PANEL EI		.D
		a v	X = LCD SID		
			t = GLASS T		
			. X		
		CHIP ON ELECTRODE PAD	a	b	c
		a a	≤t	≤ 0.5mm	≤ 1/8X
			* X=LCD SIDE		
			t =GLASS T	HICKNESS	
			a	b	c
		X	α ≤ t	≤ 1/8X	≤L
	A	V 1.5°	*X=LCD SIDE	WIDTH	-
	6	, , , , , , , , , , , , , , , , , , ,	t = GLASS TI	HICKNESS	
				DE PAD LENGT	
		0		HIPPING THE IT	O'
	X 0		TERMINAL	*	
				F THE ITO MUST	
		a	·	SPECTED ACCO E TERMINAL	אוועאים 10
	N N	у ` ь	SPECIFICAT		
	7			DUCT WILL BE	HEAT
				THE CUSTOME	
				MENT MARK M	
			BE DEMAGI	ED	

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15. RELIABILITY TEST

15.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO.	ITEM	DESCRIPTION
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS
5	HIGH TEMPERATURE /HUMIDITY TEST (STORAGE)	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: +80°C -30°C -30°C -30°C
7	ESD (ELECTROSTATIC DISCHARGE) (NOT OPERATED)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV (ACCORDING TO IEC-61000-4-2)

NOTE ($\bf 1$) : THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

15.2 TESTING CONDITIONS AND INSPECTION CRITERIA FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 15.1, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO.	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT		THE CURRENT CONSUMPTION SHOULD
1	CONSUMPTION	REFER TO SI ECH ICATION	CONFORM TO THE PRODUCT SPECIFICATION.
			AFTER THE TESTS HAVE BEEN EXECUTED, THE
2	CONTRAST	REFER TO SPECIFICATION	CONTRAST MUST BE LARGER THAN HALF OF
			ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

EMERGING	DISPLAY
TECHNOLOGIES (CORPORATION

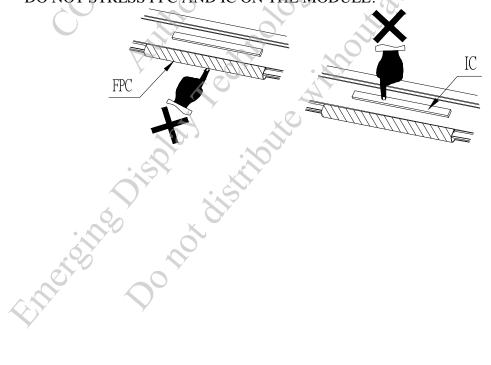
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16. CAUTION

16.1 OPERATION

- 16.1.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 16.1.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 16.1.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .
- 16.1.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE. IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH UP PROBLEM.
- 16.1.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!

 DO NOT STRESS FPC AND IC ON THE MODULE!



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16.2 NOTICE

- 16.2.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS. FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD.
- 16.2.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 16.2.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 16.2.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 16.2.5 DON'T GIVE EXTERNAL SHOCK.
- 16.2.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 16.2.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW. WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 16.2.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 16.2.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 16.2.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 16.2.11 REWIRING: NO MORE THAN 3 TIMES.

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